10 Line EMI Filter

This device is a ten-line EMI filter array for wireless applications. Greater than -35 dB attenuation is obtained at frequencies from 800 MHz to 3.0 GHz. ESD protection is provided across all capacitors.

Features

- EMI Filtering and ESD Protection
- Integration of 30 Discretes
- Provides Protection for IEC61000–4–2 (Level 4)
- ◆ 8.0 kV (Contact)
- Flip-Chip Package
- Moisture Sensitivity Level 1
- ESD Rating: Machine Model = C; Human Body Model = 3B
- Pb-Free Package is Available*

Benefits

- Reduces EMI/RFI Emissions on a Data Line
- Integrated Solution Offers Cost and Space Savings
- Reduces Parasitic Inductances Which Offer a More "Ideal" Low Pass Filter Response
- Integrated Solution Improves System Reliability

Applications

- EMI Filtering and ESD Protection for Data Lines
- Cell Phones
- Handheld Products
- MP3 Players

MAXIMUM RATINGS (T_A = 25° C unless otherwise noted)

Rating		Symbol	Value	Unit
ESD Discharge IEC61000-4-2	Contact Discharge	V _{PP}	8.0	kV
Steady-State Power per Resistor		P _R	100	mW
Steady-State Power per Package		PT	200	mW
Operating Temperature Range		T _{OP}	-40 to +85	°C
Storage Temperature Range		T _{STG}	-55 to +150	°C
Junction Temperature		TJ	+125	°C

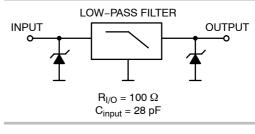
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



ON Semiconductor®

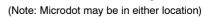
http://onsemi.com

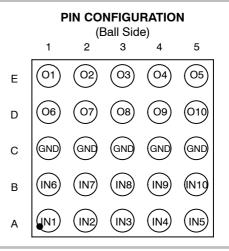






NUF9001 = Specific Device CodeA= Assembly LocationY= YearWW= Work Week•= Pb-Free Package





ORDERING INFORMATION

Device	Package	Shipping [†]
NUF9001FCT1	Flip-Chip	3000 Tape & Reel
NUF9001FCT1G	Flip–Chip (Pb–Free)	3000 Tape & Reel

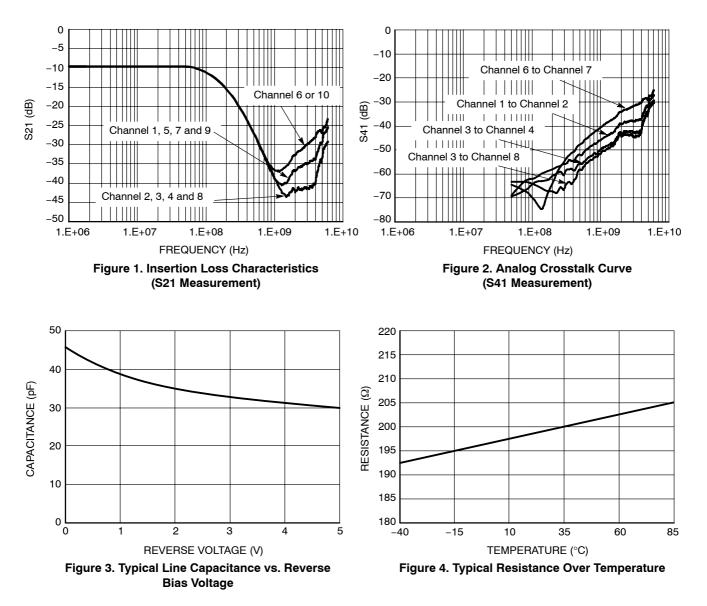
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Characteristic	Symbol	Test Conditions	Min	Тур	Max	Unit
Maximum Reverse Working Voltage	V _{RWM}	-	-	-	5.0	V
Breakdown Voltage	V _{BR}	I _R = 1.0 mA	6.0	7.0	8.0	V
Leakage Current	I _R	V _{RM} = 3.0 V	-	-	0.1	μA
Series Resistance	R _A	-	170	200	230	Ω
Capacitance	C _{LINE 1}	f = 1.0 MHz, 0 Vdc	-	45	50	pF
Cut-Off Frequency	f _{3dB}	(Above this frequency, appreciable attenuation occurs)	-	100	-	MHz

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

TYPICAL PERFORMANCE CURVES

(T_A = 25°C unless otherwise specified)



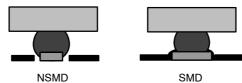
PRINTED CIRCUIT BOARD RECOMMENDATIONS

Parameter	500 μm Pitch 300 or 350 μm Solder Ball
PCB Pad Size	250 μm +25 –0
Pad Shape	Round
Pad Type	NSMD
Solder Mask Opening	350 μm ±25
Solder Stencil Thickness	125 μm
Stencil Aperture	250 x 250 μm sq.
Solder Flux Ratio	50/50
Solder Paste Type	No Clean Type 3 or Finer
Trace Finish	OSP Cu
Trace Width	150 μm Max

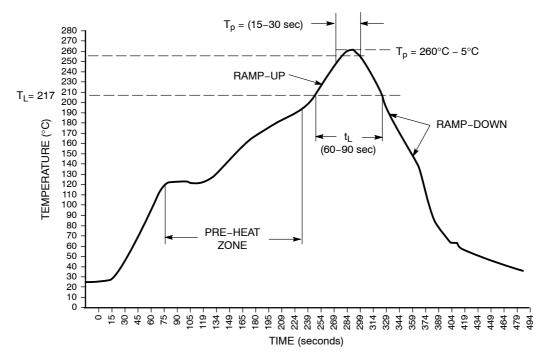
Copper

Solder mask





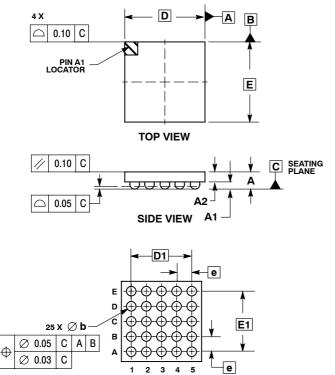






PACKAGE DIMENSIONS

FLIP-CHIP-25 CSP CASE 499G-01 **ISSUE A**



BOTTOM VIEW

NOTES

DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

2

CONTROLLING DIMENSION: MILLIMETERS. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS. 3.

	MILLIMETERS		
DIM	MIN	MAX	
Α		0.650	
A1	0.210	0.270	
A2	0.380	0.430	
D	2.650 BSC		
Е	2.650 BSC		
b	0.290	0.340	
е	0.500 BSC		
D1	2.000 BSC		
E1	2.000 BSC		

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